ESS HPRF Distribution: Technology Enhancement for High **Temperature RF** Loads

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Many thanks to







✓ Colleagues:

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Overview:

- ESS RF systems
- Earlier plans for Load Cooling
- Present plans for High Temperature cooling
- Technology enhancement & New Developments
 - * Resistive Loads
 - * Ferrite ER Load
 - * Ferrite load (ferrite tiles)
 - * Water Load







ESS HPRF Systems

Power profile along Superconducting Linac



RF Loads



RF loads: Matched terminations

Isolator Load: Used with circulator to protect amplifier To dissipate RF power during Amplifier testing



HB/MB Linac

100 loads Frequency = 704 MHz, Power = 1.5 MWp (Isolator loads) Flow requirement: 70 lpm x 100

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Reject load: RF load with 3 dB Combiner (Hybrid coupler)





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RF load with 3 dB Splitter (Hybrid coupler) as Reject load:



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Earlier Plans for Load Cooling

ESS will have three cooling circuits: 10°C, 25°C, 50°C

Loads were on medium temperature circuit ie. 25°C







Resistive loads



Heat removal is efficient

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Corrosive effects of high-purity DI water causes erosion of rf contacts. Thus resistor needs to be replaced.

To avoid fast erosion: The RF contacts are plated with Gold.

Needs maintenance !

In spite of Gold plating, after three years, resistor need to be replaced.

Courtesy: Doug Horan (ANL)

-Increase in running cost of accelerator -Increase in Man power requirement

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ALTRONIC RESEARCH INC.



- Heat removal is less efficient compared to earlier design
- Load becomes more compact as dielectric tube inside ceramic



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Proposed design For HB/MB load

- New resistor
 Development
- Zero maintenance









- Ferrite tiles glued with water cooled wall
- Zero maintenance
- RF and water circuit separate

Earlier Maximum return temperature ≈ 40°C



- To take care of heat transfer to the cooling channels
- Adhesive withstands >> 80°C
- To tare care of different thermal expansions of ferrite and AI, thermal stresses

Now outlet temperature = 80°C

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Ferrite Energy Recovery Load

Max Outlet temperature 80° C Lossy ferrite powder used as absorber

Development by MEGA, following merger of MCI into MEGA (Basic R&D was carried in CERN by Fritz Casper for loads at high frequency)



Applied on water cooled Septa

- Eliminates risk of fracture due to thermal stresses /
- As ferrite molecular density is reduced, Watt /area reduces
- Surface area increases, thus increasing avg. power handling capability /

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Proposed design for HB/MB load

- Zero maintenance
- RF and water circuit separate











ESS will be first one to use high temperature water cooled loads for Energy recovery.

The load designs are either NEW or with TECHNOLOGY ENHANCEMENT !

RF GROUP IS TAKING RISK

Thank you !

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Notes on Isolation



Isolation of a Circulator Shorted at Port 2, Load at Port 3



The reflection coefficient R_T seen by the RF generator depends on the circulator S_{11} and the intrinsic isolation S_{12} but also on reflection coefficient R3 of the dummy load!





Different Operating scenarios

Power to the load during matched Beam operation



6000 hours/year: When machine is running

Increase in outlet temperature < 1°C

Power to the load during Amplifier testing

Testing time < 600 hours / year

Increase in outlet temperature \approx 10 °C



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Time

